

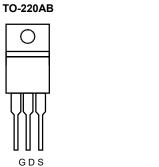
77N6F6-VB Datasheet N-Channel 60 V (D-S) MOSFET

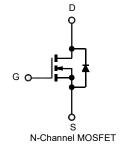
PRODUCT SUMMARY		
V _{DS}	60	V
R _{DS(on)} V _{GS} = 10 V	5	mΩ
ID	120	A
Configuration	Sin	gle

FEATURES

- 175 °C Junction Temperature
- TrenchFET[®] Power MOSFET
- Material categorization:







ABSOLUTE MAXIMUM RATINGS (T _C = 25	°C, unless otherw	vise noted)			
Parameter		Symbol	Limit	Unit	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T = 175 °C)b	T _C = 25 °C	1-	120		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 100 °C	ID -	90		
Pulsed Drain Current		I _{DM}	350	A	
Continuous Source Current (Diode Conduction)		I _S	70 ^a		
Avalanche Current		I _{AS}	50	1	
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	125	mJ	
Maximum Dawar Dissinction	T _C = 25 °C	Р	136	w	
Maximum Power Dissipation	T _A = 25 °C	P _D -	3 ^b , 8.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marine un lun stien te Anchienta	$t \le 10 \text{ sec}$	R _{thJA}	15	18	
Maximum Junction-to-Ambient ^a	Steady State	' ` thJA	40	50	°C/W
Maximum Junction-to-Case		R _{thJC}	0.85	1.1	

Notes:

a. Package limited.b. Surface mounted on 1" x 1" FR4 board.

c. t ≤ 10 s.

SPECIFICATIONS (T _J = 25 °C) Parameter	1 1	Test Conditions	Min.		Mox	Unit	
	Symbol	Test Conditions	Min.	Typ.ª	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		4	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		V_{DS} = 60 V, V_{GS} = 0 V			1		
	I _{DSS}	V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μA	
		V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V_{DS} = 5 V, V_{GS} = 10 V	60			Α	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A		5		mΩ	
		V_{GS} = 10 V, I _D = 20 A, T _J = 125 °C		10			
		V_{GS} = 10 V, I _D = 20 A, T _J = 175 °C		15			
		V _{GS} = 7.5 V, I _D = 15 A		8			
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic					1		
Input Capacitance	C _{iss}			6800			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		570		pF	
Reverse Transfer Capacitance	C _{rss}			325		1	
Total Gate Charge ^c	Qg			47	70		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 50 A		10		nC	
Gate-Drain Charge ^c	Q _{gd}			12			
Turn-On Delay Time ^c	t _{d(on)}			10	20		
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 V_{DD} = 30 V, RL = 0.6 Ω

 $I_D\,\widetilde{=}\,50$ A, V_{GEN} = 10 V, R_g = 2.5 Ω

I_F = 20 A, V_{GS} = 0 V

I_F = 20 A, di/dt = 100 A/µs

Notes:

Rise Time^c

Fall Time^c

Pulsed Current

Turn-Off Delay Time^c

Diode Forward Voltage

Reverse Recovery Time

a. For design aid only; not subject to production testing.

Source-Drain Diode Ratings and Characteristics (T_C = 25 °C)

t_r

 ${\rm t}_{\rm d(off)}$ tf

I_{SM}

 V_{SD}

t_{rr}

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

15

35

20

350

1

45

25

50

30

1.5

100

ns

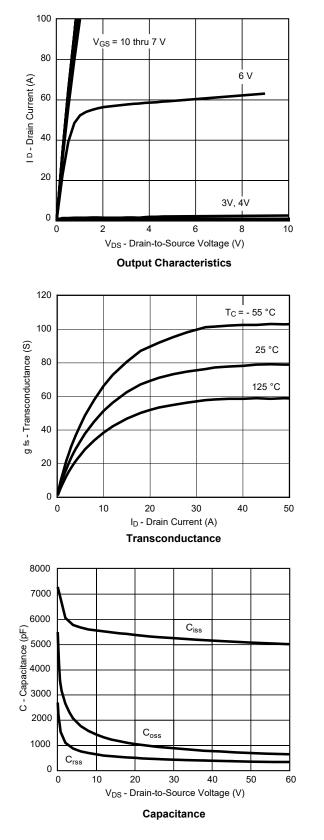
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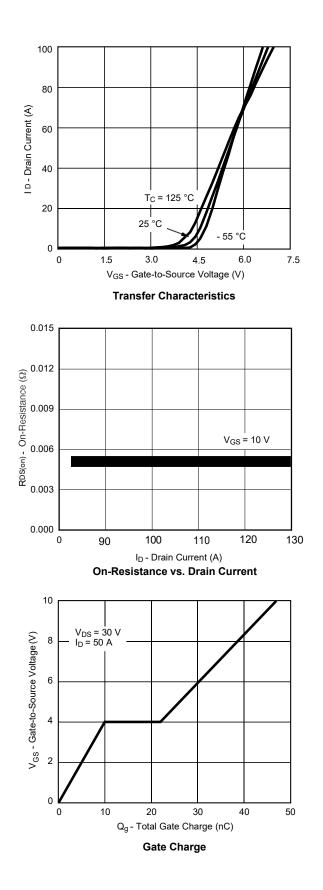
V

ns

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TYPICAL CHARACTERISTICS (25 °C unless noted)



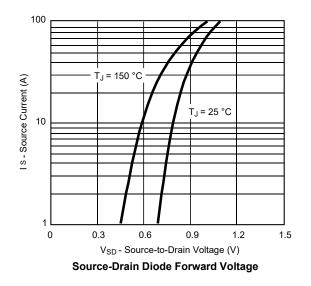




TYPICAL CHARACTERISTICS (25 °C unless noted)

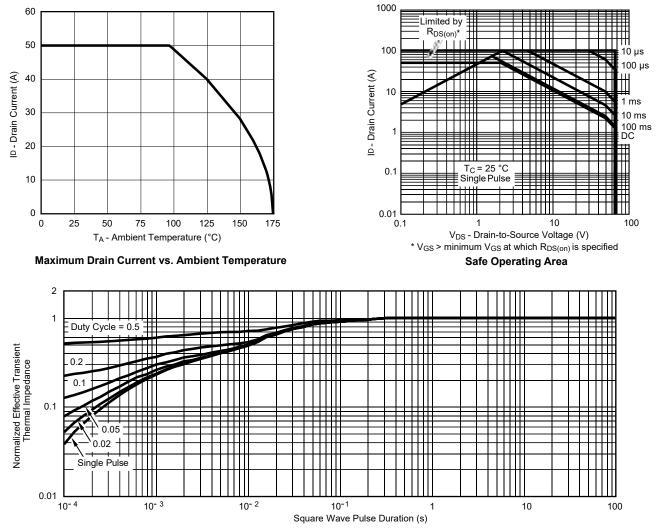


On-Resistance vs. Junction Temperature





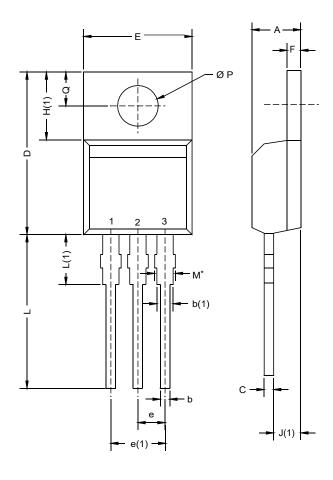
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12- DWG: 547	-0208-Rev. N, 1	08-Oct-12			

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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